

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s):

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Assignee:

Amkor and ANAM (Jointly)

Title:

Nonexposed Heat Sink For Semiconductor Package

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Chuong A. Luu

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INFORMATION DISCLOSURE STATEMENT **UNDER CFR § 1.97(c) WITH FEE**

Dear Sir:

Pursuant to 37 C.F.R. § 1.56, § 1.97 and § 1.98, Applicant(s) wish to call the following documents (copies enclosed) to the attention of the Examiner.

A PTO form 1449 listing these documents is enclosed.

Citation of the above documents shall not be construed as:

- an admission that the documents are necessarily prior art with respect to the instant invention;
 - 2. a representation that a search has been made, or
- an admission that the information cited herein is, or is considered to be, material to patentability as defined in § 1.56(b).

Please charge Deposit Account No. 19-2386 \$180.00 for the Information Disclosure Statement fee under 37 C.F.R. § 1.17(p). The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Deposit Account 19-2386. This paper is being submitted in duplicate.

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Serial No. 09/513,067

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Respectfully submitted,